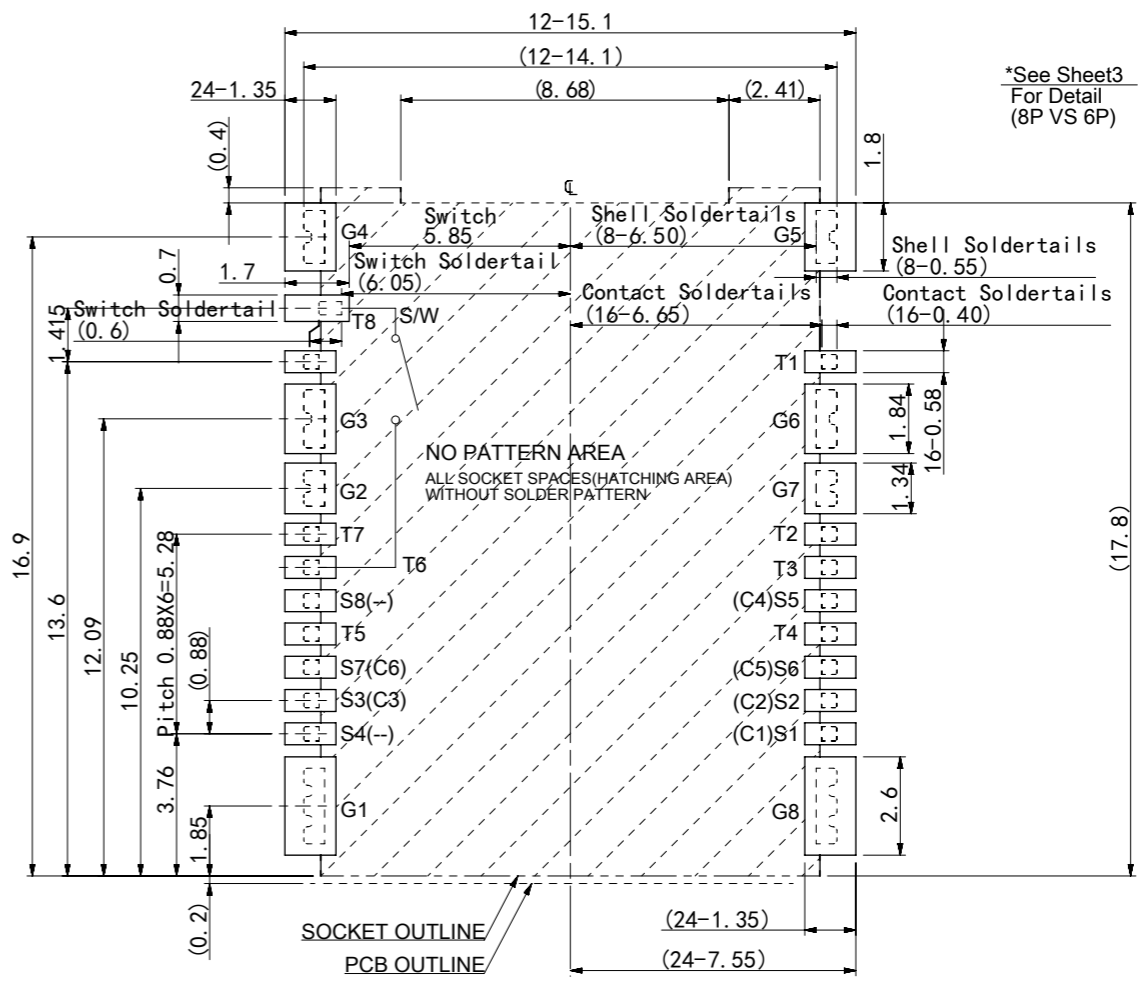


-DATE CODE-  
example: MZB15A1  
M-> Molex initial  
2-> Year(2012)  
B-> Month(November) 1, ...,9, A, B, C  
15-> Date(15th)  
A-> Site initial(Ansan)  
1-> Manufacture line number



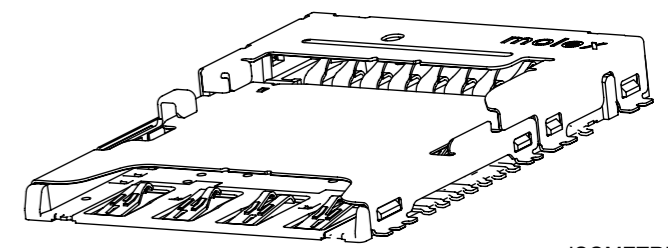
[microSIM CARD PIN-MAP]

8P	6P	DESCRIPTION
S1	C1	Vcc(Supply V)
S2	C2	RST(Reset)
S3	C3	CLK(Clock)
S4	--	Reserved
S5	C4	GND
S6	C5	Vpp(Program V)
S7	C6	I/O
S8	--	Reserved
G1~G8		GND

[microSD CARD PIN-MAP]

PIN NO.	DESCRIPTION
T1	DAT2
T2	CD/DAT3 <sup>2</sup>
T3	CMD
T4	Vdd
T5	CLK
T6	Vss(GND)
T7	DAT0
T8	DAT1
S/W	CARD DETECTOR

RECOMMENDED PCB LAYOUT [FRONT VIEW]  
[TOLERANCE : ±0.05]



ISOMETRIC (SCALE 4/1)

- NOTES
1. MATERIALS: SEE TABLE
  2. FINISHES: SEE TABLE
  3. MATES WITH  
-UPPER: microSD Card  
-LOWER: microSIM(UICC) Card
  4. PRODUCT SPECIFICATIONS: PS-104642-001
  5. PACKING SPECIFICATIONS: SPK-104642-002
  6. COPLANARITY OF SOLDER TAILS:  
0.08mm MAX. BEFORE & AFTER 250°C REFLOW 2TIMES
  7. REFERENCE CARD DIMENSIONS ARE WITH STANDARD DIMENSION CARD
  8. CUSTOMER'S CTF DIMENSION(☆) IS EQUAL TO MOLEX MAJOR QUALITY SYMBOL(▼)

[Circuit diagram for Detection Switch of microSD card]

card insertion condition	card detect switch	Circuit mSD #6pin Switch terminal
Without Card	Open	
Card insertion	Close	

NO.	PARTS NAME	MATERIALS	FINISHES
1	CONTACT TERMINAL (16P)	COPPER ALLOY	CONTACT mSIM: GOLD 0.05µm MIN. OVER Pd-Ni 0.3µm MIN. CONTACT mSD: GOLD 0.05µm MIN. Pd-Ni 0.2µm MIN. SWITCH: GOLD 0.1µm MIN. (Pd-Ni IS PALLADIUM NICKEL) SOLDERS: GOLD 0.05µm MIN. BASE: NICKEL 1.27 MIN.
2	SWITCH TERMINAL	PHOSPHOR BRONZE	
3	microSD SHELL	STAINLESS STEEL	BRIGHT NICKEL 1.27µm MIN.
4	microSIM SHELL	STAINLESS STEEL	BRIGHT NICKEL 1.27µm MIN.
5	HOUSING	LIQUID CRYSTAL POLYMER	NATURAL(IVORY) COLOR, UL94V-0
6	EJECT PULLER	STAINLESS STEEL	NONE

QUALITY SYMBOLS	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION
FA = 0	EC NO: 107531 DRWN: EGMKIM CHK'D: SHCHU APPR: YSKIM02 REDRAWN 2016/09/01 2016/08/29 2016/08/29 GENERAL TOLERANCES (UNLESS SPECIFIED) ANGULAR TOL ± 1.0 ° 4 PLACES ± 3 PLACES ± 0.12 2 PLACES ± 0.12 1 PLACE ± 0.15 0 PLACES ± 0.15 DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS DIMENSION UNITS: MM SCALE: 5:1 DRWN BY: YHJUNG02 DATE: 2016/04/14 CHK'D BY: SHCHU DATE: 2016/08/29 APPR BY: YSKIM02 DATE: 2016/08/29 DRAWING SIZE: A3 THIRD ANGLE PROJECTION
FE = 0	
FB = 0	
▼ = 1	
FC = 0	
FX = 0	
■ = 0	
▽ = 0	
□ = 0	
◇ = 0	
◇ = 0	

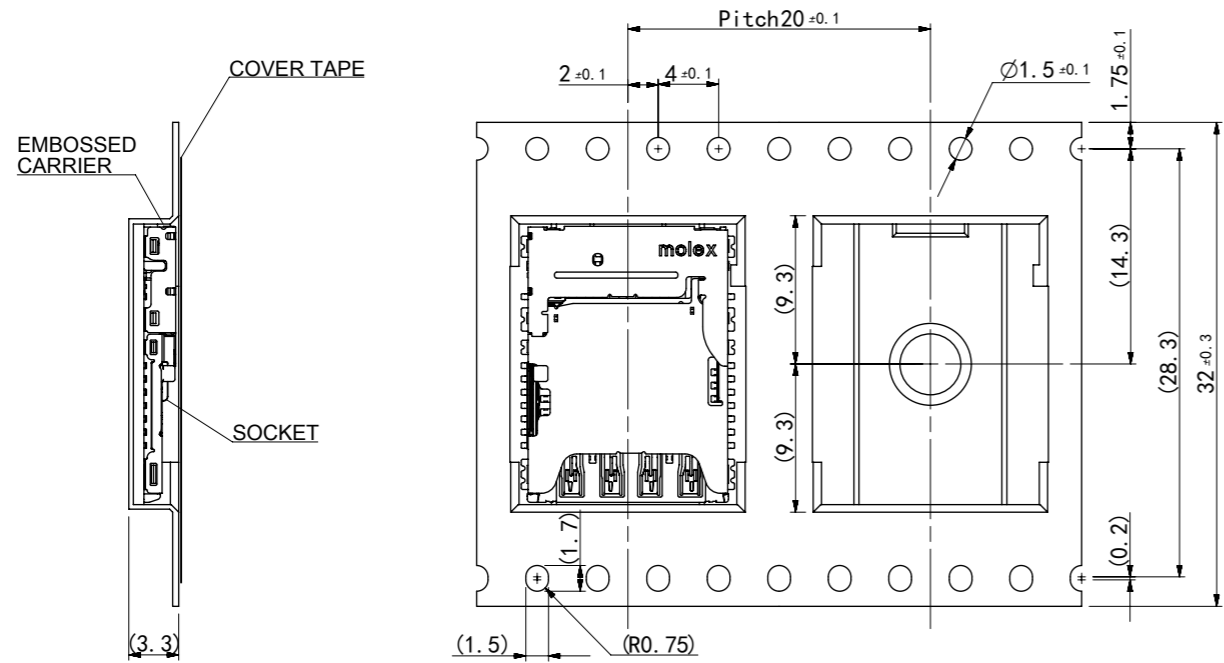
SMD ONLY	104642-1610	1046421610
SOLDER TYPE	PART (ORDER) NO.	MATERIAL NO.

**molex**

**COMBO 2.10H PULLER TYPE  
MICROSD/MICROSIM 8P/8P WITH S/W**

**PRODUCT CUSTOMER DRAWING**

SERIES	MATERIAL NUMBER	CUSTOMER
104642		GENERAL
DOCUMENT NUMBER	DOC TYPE	DOC PART
1046421610	PSD	000
SHEET NUMBER		1 OF 3

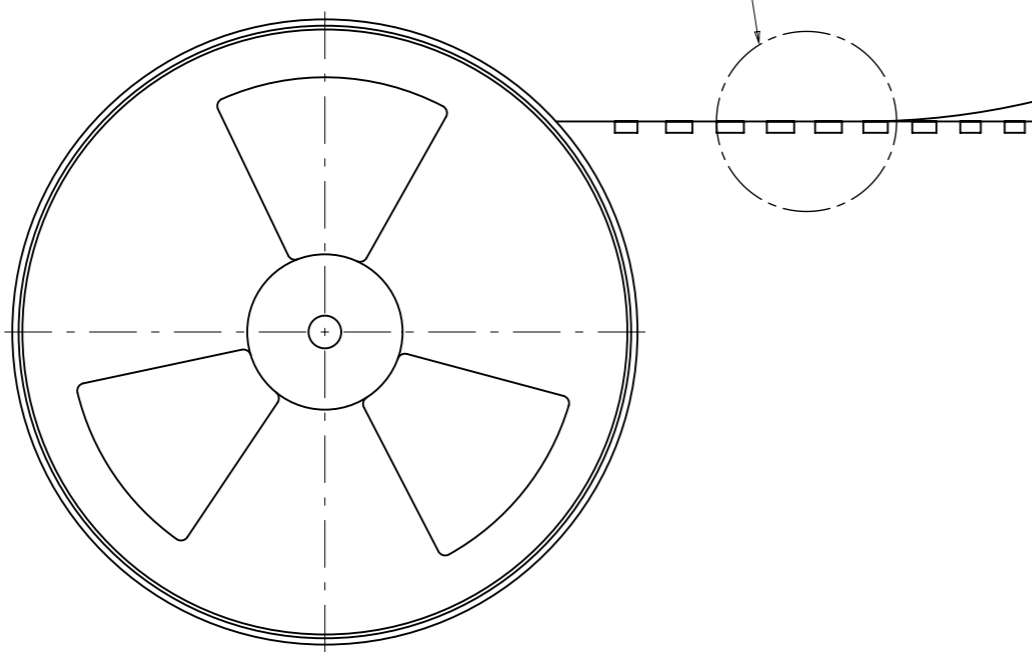
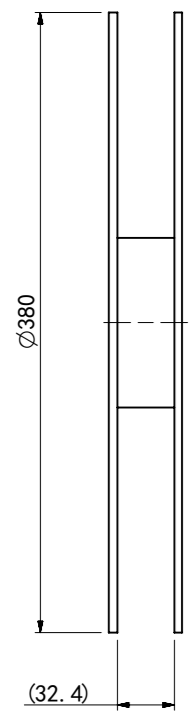


TOP VIEW OF EMBOSSED CARRIER

UNREELING OF PRODUCTS DIRECTION

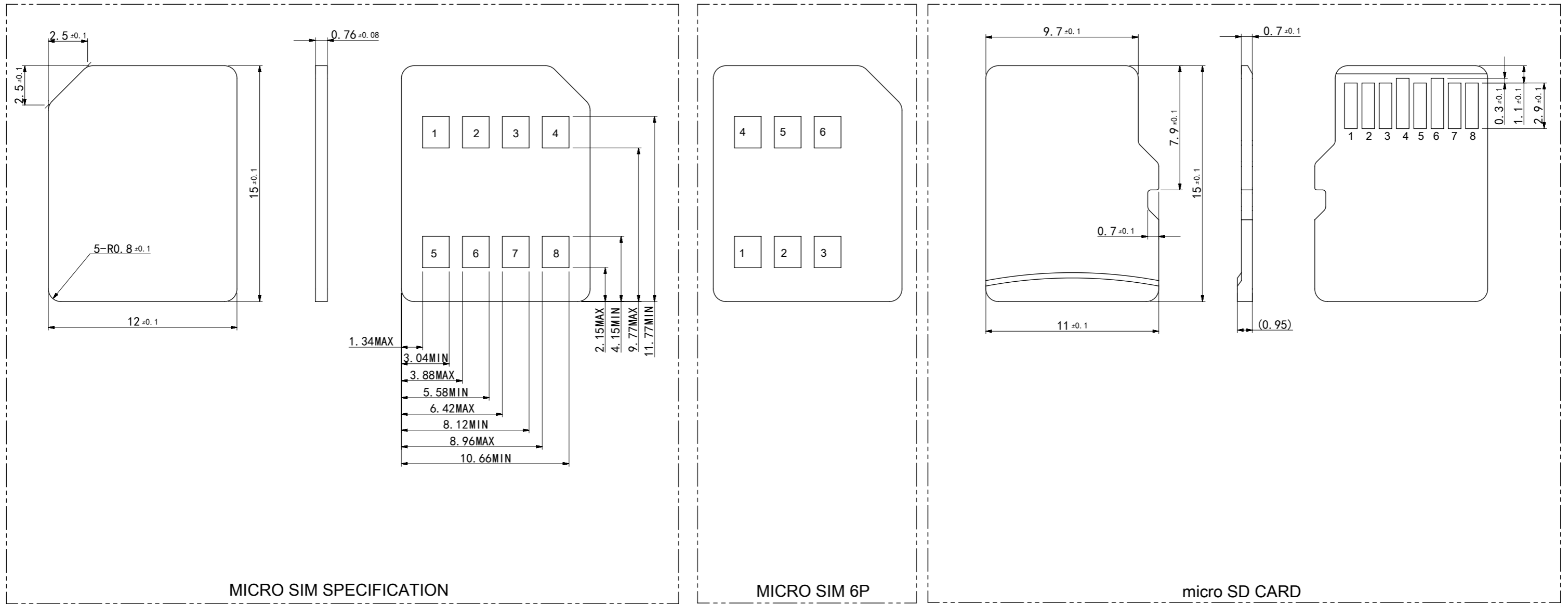
NOTES

1. QUANTITY OF PRODUCTS: 1,500 PCS /1 REEL
2. LEAD LENGTH
  - COVER TAPE NON-BONDED PART: 25 ±10
  - NUMBER OF EMPTY PART: 10 ~ 20PCS
  - UNREELING DIRECTION
  - COVER TAPE
  - TAIL PART (EMPTY) (60MIN.)
  - COMPONENT SUPPLIER
  - 400 ±80
3. PEELING OFF FORCE OF COVER TAPE: 0.1N~0.59N(10.2~60gf)  
 (PEELING DIRECTION AS BELOW)  
 -PEELING OFF SPEED: 300mm/Min.(Ref.)
  - REEL OFF DIRECTION
  - 10°
  - UNREELING DIRECTION
4. MATERIALS OF EMBOSSED CARRIER AND COVER TAPE: PET(POLYETHYLEN TEREPHTHALATE)



THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION													
QUALITY SYMBOLS	REDRAWN	EC NO: 107531	DRWN: ECKIM	CHK'D: SHCHU	APP'R: YSKIM02	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION UNITS	SCALE				
						4 PLACES ±	3 PLACES ± 0.12	MM	2:1				
▽A = 0		2016/09/01		2016/08/29	2016/08/29	ANGULAR TOL ± 1.0 °	2 PLACES ± 0.12	DRWN BY	DATE	COMBO 2.10H PULLER TYPE MICROSD/MICROSIM 8P/8P WITH S/W			
▽E = 0					1 PLACE ± 0.15	YHJUNG02	2016/04/14	CHK'D BY	DATE				
▽F = 0					0 PLACES ± 0.15	2 PLACES ± 0.12	SHCHU	2016/08/29	DATE	PRODUCT CUSTOMER DRAWING			
▽ = 0					DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	1 PLACE ± 0.15	YSKIM02	2016/08/29	APP'R BY				DATE
▽C = 0								YHJUNG02	2016/04/14	SERIES	MATERIAL NUMBER	CUSTOMER	
▽ = 0								YSKIM02	2016/08/29	104642	SEE SHEET 1	GENERAL	
▽ = 0										DOCUMENT NUMBER	DOC TYPE	DOC PART	SHEET NUMBER
▽ = 0										1046421610	PSD	000	2 OF 3

# REFERENCE DRAWING



MICRO SIM SPECIFICATION

MICRO SIM 6P

micro SD CARD

[Reference Standards]  
 -.microSD CArd Addendum Versopm 3.0 Draft 0.8  
 -.ETSI TS 102 221 V9.1.0, Smart Cards, UICC-Terminal interface, Physical and logical characteristics

<b>QUALITY SYMBOLS</b> FA = 0 FE = 0 FP = 0 FV = 0 FC = 0 FX = 0 FS = 0 FT = 0	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION																				
	REDRAWN EC NO: 107531 DRWN: ECKIM CHK'D: SHCHU APPR: YSKIM02	2016/09/01		2016/08/29		2016/08/29		GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION UNITS: MM SCALE: 4:1											
		ANGULAR TOL ± 1.0 °						4 PLACES ±		DRWN BY: YHJUNG02		DATE: 2016/04/14									
		3 PLACES ± 0.12						3 PLACES ± 0.12		CHK'D BY: SHCHU		DATE: 2016/08/29									
		2 PLACES ± 0.12						2 PLACES ± 0.12		APPR BY: YSKIM02		DATE: 2016/08/29									
		1 PLACE ± 0.15						1 PLACE ± 0.15		DRAWING SIZE: A3		THIRD ANGLE PROJECTION									
	0 PLACES ± 0.15						0 PLACES ± 0.15		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS												
											COMBO 2.10H PULLER TYPE MICROSD/MICROSIM 8P/8P WITH S/W										
	PRODUCT CUSTOMER DRAWING										SERIES: 104642		MATERIAL NUMBER: SEE SHEET 1		CUSTOMER: GENERAL						
	RELEASE STATUS: P1										RELEASE DATE: 01.09.2016		23:51:41		DOCUMENT NUMBER: 1046421610		DOC TYPE: PSD		DOC PART: 000		SHEET NUMBER: 3 OF 3